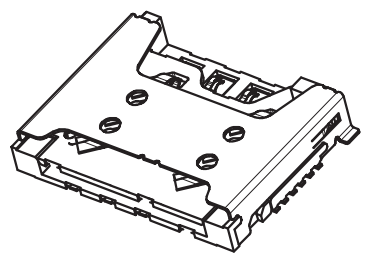


NOTE:

- MATERIAL:
HOUSING: THERMOPLASTIC, BLACK, UL 94V-0
CONTACT: COPPER ALLOY.
SHELL: STAINLESS STEEL.
- FINISH:
CONTACT: GOLD PLATING 1u"Min., SOLDER AREA
100u" TIN PLATED OVER NICKEL
- SPECIFICATION:
CONTACT RESISTANCE: 80m Ω MAX.
INSULATION RESISTANCE: 1000M Ω MIN.
DIELECTRIC WITHSTANDING VOLTAGE: 500V AC MIN FOR 1 MINUTE.
DURABILITY: 5000 CYCLES.

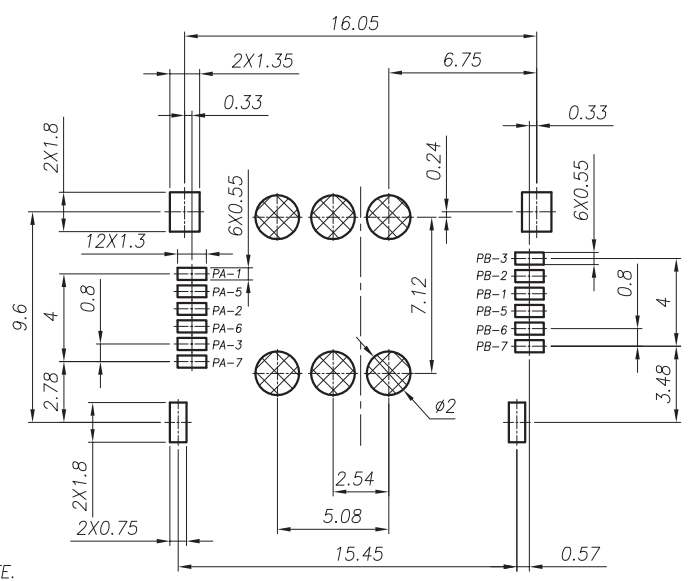
6. PART No.: S 0 DL - 28 00 12- 10 G
 SIM CON. | G=gold flash
 0=WITHOUT POST | 10=Product Order
 DL=DUAL TYPE. | Pin NO. 12=12Pin
 28:HEIGHT 2.8mm | 00=0N PCB



SIM CARD PIN NO.	PIN NO.
P1-A/B	VCC
P2-A/B	RST
P3-A/B	CLK
P5-A/B	GND
P6-A/B	VPP
P7-A/B	I/O

REV.	ECN NO OR DESCRIPTION	REVISED	DATE
▽	PROPOSE ONLY	ALLEN	2015.03.28

PATTERN PROHIBITION AREA



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES: ±0.05

③	TERMINAL	12	C5210-EH, T=0.12	Au 5u" PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H, T=0.15	AU/Ni PLATING
NO.	PART NAME	Q'TY	DESCRIPTION	NOTE

UNLESS OTHERWISE SPECIFIED TOLERANCES

Wellco T&C Co., Ltd.

DECIMALS:	ANGLES:	TITLE	DUAL Micro SIM 2 in 1 Card Conn.		
x :±0.5	X :±2°	DWN	ALLEN	PART NO. SODL-280012-10G	
X.X :±0.20	X.X :±1°	CHKD	KEVIN	SCALE: 1:1	UNIT: mm
X.XX :±0.10		APVD	ERIC.W	SIZE: A3	SHEET: 10F 1
CUSTOMER COPY					